

# 4-Bit Dual-Supply Level Translator

## NL3V4T244, NL3V4T240, NL3V4T3144

The NL3V4T244 / NL3V4T240 / NL3V4T3144 are 4-bit configurable dual-supply level translators with 3-state outputs. The A- and B- ports are designed to track two different power supply rails,  $V_{CCA}$  and  $V_{CCB}$  respectively. Both supply rails are configurable from 0.9 V to 3.6 V allowing universal voltage level translation between the A- to B- ports.

The NL3V4T244 is a 4-bit level translator that allows non-inverting translations from A to B ports. The NL3V4T240 is a 4-bit level translator that allows inverting translations from A to B ports. The NL3V4T3144 is a 4-bit level translator that allows 3-bits of non-inverting translations from A to B ports and 1 bit of non-inverting translation from B to A.

The output enable pin ( $\overline{OE}$ ), when High, disables all the output ports by putting them in 3-state. The  $\overline{OE}$  pin is designed to track  $V_{CCA}$ .

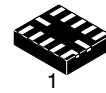
### Features

- Wide  $V_{CCA}$  and  $V_{CCB}$  Operating Range: 0.9 V to 3.6 V
- Balanced Output Drive:  $\pm 24$  mA @ 3.0 V
- High-Speed w/ Balanced Propagation Delay: 2.8 ns max at 3.0 to 3.6 V
- Input/Output Pins OVT to 3.6 V
- Non-preferential  $V_{CC}$  Sequencing
- Outputs at 3-State until Active  $V_{CC}$  is Reached
- Partial Power-Off Protection
- Outputs Switch to 3-State with either  $V_{CC}$  at GND
- Typical Max Data Rates:
  - 380 Mbps ( $\geq 1.8$ -V to 3.3-V Translation)
  - 200 Mbps ( $\geq 1.1$ -V to [1.8-V, 2.5-V, 3.3-V] Translation)
  - 150 Mbps ( $\geq 1.1$ -V to 1.5-V Translation)
  - 100 Mbps ( $\geq 1.1$ -V to 1.2-V Translation)
- Small Pb-Free Packaging: TSSOP-14, SOIC-14, UQFN12
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable\*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

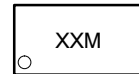
### Typical Applications

- Mobile Phones, PDAs, Other Portable Devices
- Automotive
- Industrial

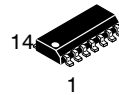
### MARKING DIAGRAMS



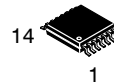
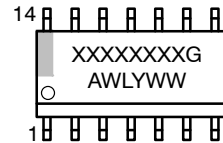
UQFN12  
MU SUFFIX  
CASE 523AE



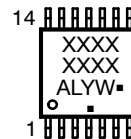
XX = Specific Device Code  
M = Date Code



SOIC-14  
D SUFFIX  
CASE 751A



TSSOP-14  
DT SUFFIX  
CASE 948G



A = Assembly Location  
WL, L = Wafer Lot  
Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

# NL3V4T244, NL3V4T240, NL3V4T3144

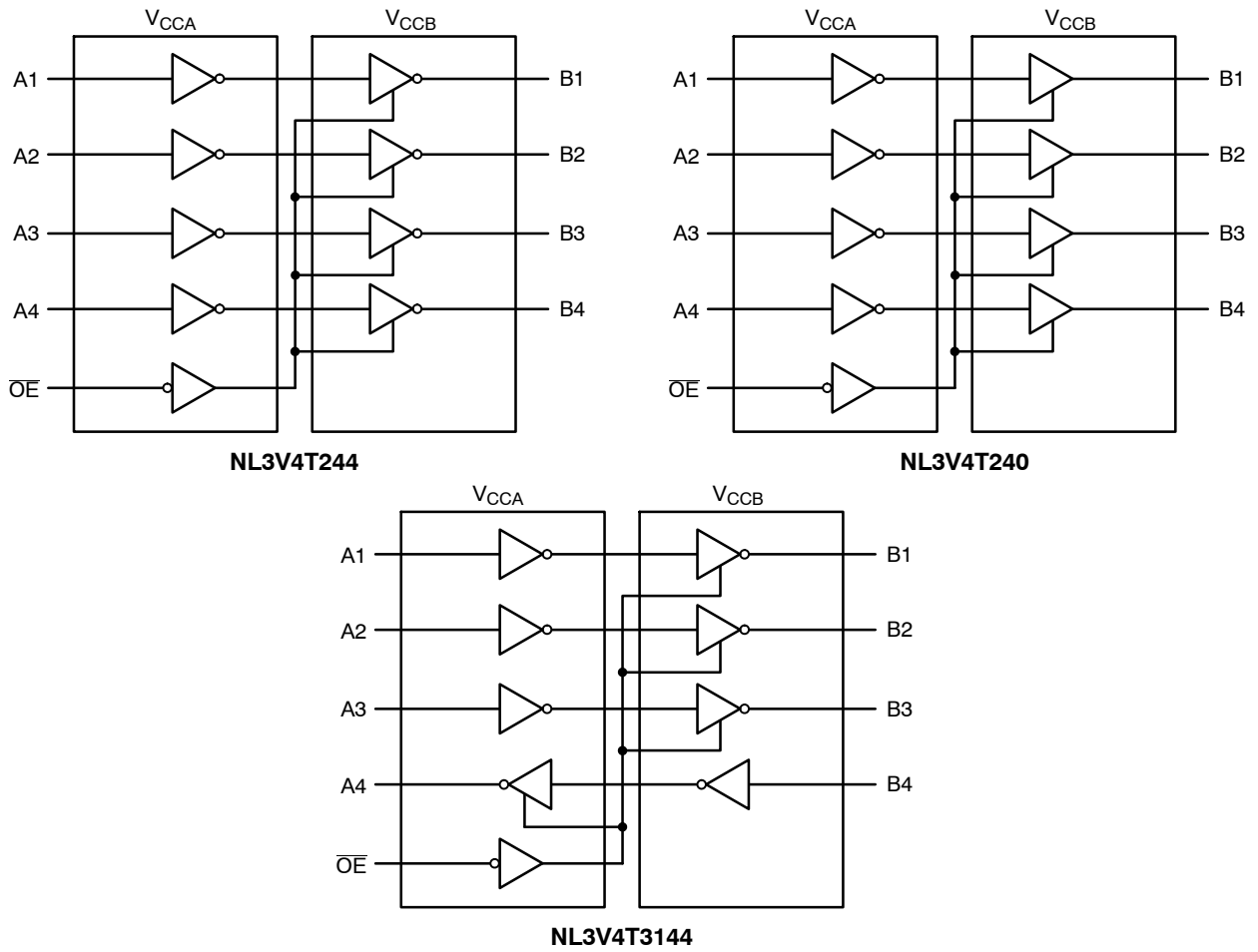


Figure 1. Logic Diagrams

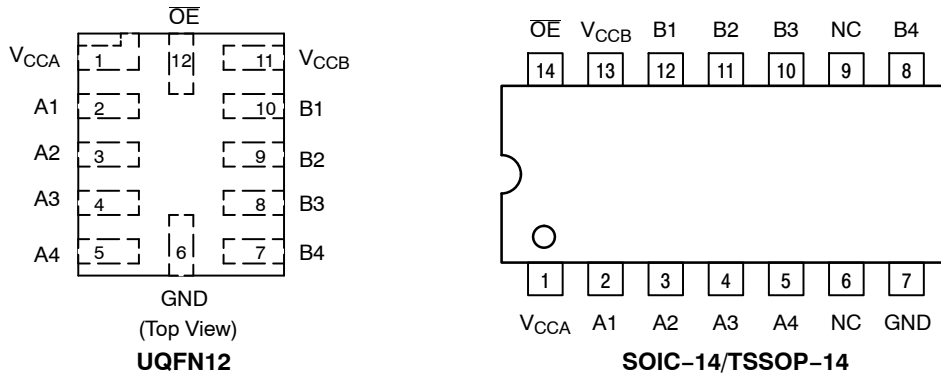


Figure 2. Pin Assignments (Top View)

## NL3V4T244, NL3V4T240, NL3V4T3144

**FUNCTION TABLE – NL3V4T244**

Inputs		Output
$\overline{OE}$	$A_n$	$B_n$
L	L	L
L	H	H
H	X	3-State

**FUNCTION TABLE – NL3V4T240**

Inputs		Output
$\overline{OE}$	$A_n$	$B_n$
L	L	H
L	H	L
H	X	3-State

**FUNCTION TABLE – NL3V4T3144**

Inputs		Output
$\overline{OE}$	A1,A2,A3,B4	B1,B2,B3,A4
L	L	L
L	H	H
H	X	3-State

**PIN ASSIGNMENT – NL3V4T244, NL3V4T240**

PIN	FUNCTION
$V_{CCA}$	A-Port DC Power Supply
$V_{CCB}$	B-Port DC Power Supply
GND	Ground
$\overline{OE}$	Output Enable
A1, A2, A3, A4	Input Ports
B1, B2, B3, B4	Output Ports

**PIN ASSIGNMENT – NL3V4T3144**

PIN	FUNCTION
$V_{CCA}$	A-Port DC Power Supply
$V_{CCB}$	B-Port DC Power Supply
GND	Ground
$\overline{OE}$	Output Enable
A1, A2, A3, B4	Input Ports
B1, B2, B3, A4	Output Ports

### Application Recommendations

During power-up and power-down, it is recommended that the  $\overline{OE}$  pin be connected to  $V_{CC}$  through pull-up resistors to ensure high impedance at the I/O ports.

# NL3V4T244, NL3V4T240, NL3V4T3144

## MAXIMUM RATINGS

Symbol	Rating	Value	Condition	Unit
$V_{CCA}, V_{CCB}$	DC Supply Voltage	-0.5 to +4.3		V
$V_I$	DC Input Voltage	OE, A, B		V
$V_O$	DC Output Voltage	(Power Down Mode) A, B	$V_{CCA} = V_{CCB} = 0$	V
		(3-State Mode) A, B		
		(Active Mode) A		
		(Active Mode) B		
$I_{IK}$	DC Input Diode Current	-50	$V_I < \text{GND}$	mA
$I_{OK}$	DC Output Diode Current	-50	$V_O < \text{GND}$	mA
$I_O$	DC Output Source/Sink Current	$\pm 50$		mA
$I_{CC}$	DC Supply Current Per Supply Pin	$\pm 100$		mA
$I_{GND}$	DC Ground Current per Ground Pin	$\pm 100$		mA
$T_{STG}$	Storage Temperature Range	-65 to +150		°C
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC-14	116	°C/W
		TSSOP-14	150	
		UQFN12	143	
$P_D$	Power Dissipation in Still Air	SOIC-14	1077	mW
		TSSOP-14	833	
		UQFN12	875	
MSL	Moisture Sensitivity Level		Level 1	-
$F_R$	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
$V_{ESD}$	ESD Withstand Voltage (Note 2)	Human Body Model	2	kV
		Charged Device Model	1	
$I_{LATCHUP}$	Latchup Performance (Note 3)		$\pm 100$	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
2. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued per JEDEC/JEP172A.
3. Tested to EIA/JESD78 Class II.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
$V_{CCA}, V_{CCB}$	Positive DC Supply Voltage	0.9	3.6	V
$V_I$	Input Voltage	GND	3.6	V
$V_{IO}$	Output Voltage	(Power Down Mode) A, B	3.6	V
		(3-State Mode) A, B	3.6	
		(Active Mode) A	$V_{CCA}$	
		(Active Mode) B	$V_{CCB}$	
$T_A$	Operating Temperature Range	-40	+125	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate	0	5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# NL3V4T244, NL3V4T240, NL3V4T3144

## DC ELECTRICAL CHARACTERISTICS – INPUT VOLTAGES

Symbol	Parameter	Test Conditions	Port	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	–40°C to +85°C			–40°C to +125°C		Unit	
						Min	Typ (Note 4)	Max	Min	Max		
V <sub>IH</sub>	Input HIGH Voltage		OE, A	2.7 – 3.6	0.9 – 3.6	2.0	–	–	2.0	–	V	
				2.3 – 2.7		1.6	–	–	1.6	–		
				1.65–1.95		0.65 V <sub>CCA</sub>	–	–	0.65 V <sub>CCA</sub>	–		
				1.1 – 1.6		0.7 V <sub>CCA</sub>	–	–	0.7 V <sub>CCA</sub>	–		
				0.9		–	0.9 V <sub>CCA</sub>	–	–	–		
			B	0.9 – 3.6	2.7 – 3.6	2.0	–	–	2.0	–		V
				2.3 – 2.7	1.6	–	–	1.6	–			
				1.65–1.95	0.65 V <sub>CCB</sub>	–	–	0.65 V <sub>CCB</sub>	–			
				1.1 – 1.6	0.7 V <sub>CCB</sub>	–	–	0.7 V <sub>CCB</sub>	–			
				0.9	–	0.9 V <sub>CCB</sub>	–	–	–			
V <sub>IL</sub>	Input LOW Voltage		OE, A	2.7 – 3.6	0.9 – 3.6	–	–	0.8	–	0.8	V	
				2.3 – 2.7		–	–	0.7	–	0.7		
				1.65–1.95		–	–	0.35 V <sub>CCA</sub>	–	0.35 V <sub>CCA</sub>		
				1.1 – 1.6		–	–	0.3 V <sub>CCA</sub>	–	0.3 V <sub>CCA</sub>		
				0.9		–	0.1 V <sub>CCA</sub>	–	–	–		
			B	0.9 – 3.6	2.7 – 3.6	–	–	0.8	–	0.8		V
				2.3 – 2.7	–	–	0.7	–	0.7			
				1.65–1.95	–	–	0.35 V <sub>CCB</sub>	–	0.35 V <sub>CCB</sub>			
				1.1 – 1.6	–	–	0.3 V <sub>CCB</sub>	–	0.3 V <sub>CCB</sub>			
				0.9	–	0.1 V <sub>CCB</sub>	–	–	–			

4. All typical values are at T<sub>A</sub> = 25°C.

# NL3V4T244, NL3V4T240, NL3V4T3144

## DC ELECTRICAL CHARACTERISTICS – OUTPUT VOLTAGES

Symbol	Parameter	Test Conditions	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	-40°C to +85°C			-40°C to +125°C		Unit	
					Min	Typ (Note 4)	Max	Min	Max		
V <sub>OH</sub>	Output HIGH Voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> :								V	
		I <sub>OH</sub> = -100 μA	A	0.9	0.9	-	V <sub>CCA</sub> - 0.1	-	-		-
			B	0.9	0.9	-	V <sub>CCB</sub> - 0.1	-	-		-
		I <sub>OH</sub> = -3 mA	A	1.1 - 3.6	1.1 - 3.6	V <sub>CCA</sub> - 0.1	-	-	V <sub>CCA</sub> - 0.1		-
			B			V <sub>CCB</sub> - 0.1	-	-	V <sub>CCB</sub> - 0.1		-
		I <sub>OH</sub> = -6 mA		1.1	1.1	0.85	-	-	0.85		-
		I <sub>OH</sub> = -8 mA		1.4	1.4	1.05	-	-	1.05		-
		I <sub>OH</sub> = -8 mA		1.65	1.65	1.2	-	-	1.2		-
		I <sub>OH</sub> = -12 mA		2.3	2.3	1.8	-	-	1.8		-
				2.7	2.7	2.2	-	-	2.2		-
		I <sub>OH</sub> = -18 mA		2.3	2.3	1.7	-	-	1.7		-
	3.0		3.0	2.4	-	-	2.4	-			
I <sub>OH</sub> = -24 mA		3.0	3.0	2.2	-	-	2.2	-			
V <sub>OL</sub>	Output LOW Voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> :								V	
		I <sub>OL</sub> = 100 μA		0.9	0.9	-	0.1	-	-		-
			1.1 - 3.6	1.1 - 3.6	-	-	0.1	-	0.1		
		I <sub>OL</sub> = 3 mA		1.1	1.1	-	-	0.25	-		0.25
		I <sub>OL</sub> = 6 mA		1.4	1.4	-	-	0.35	-		0.35
		I <sub>OL</sub> = 8 mA		1.65	1.65	-	-	0.3	-		0.3
				2.3	2.3	-	-	0.4	-		0.4
		I <sub>OL</sub> = 12 mA		2.7	2.7	-	-	0.4	-		0.4
				2.3	2.3	-	-	0.4	-		0.4
		I <sub>OL</sub> = 18 mA		3.0	3.0	-	-	0.4	-		0.4
				3.0	3.0	-	-	0.55	-		0.55

## DC ELECTRICAL CHARACTERISTICS – LEAKAGE AND SUPPLY CURRENTS

Symbol	Parameter	Test Conditions	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	-40°C to +85°C		-40°C to +125°C		Unit	
					Min	Max	Min	Max		
I <sub>I</sub>	Input Leakage Current	V <sub>I</sub> = 3.6 V or GND	0.9 - 3.6	0.9 - 3.6	-	±1.0	-	±5.0	μA	
I <sub>OZ</sub>	3-State Output Leakage	$\overline{OE}$ = V <sub>IH</sub> ; V <sub>O</sub> = GND to 3.6 V	3.6	3.6	-	±1.0	-	±5.0	μA	
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V	A	0	0.9 - 3.6	-	±1.0	-	±5.0	μA
			B	0.9 - 3.6	0	-	±1.0	-	±5.0	
I <sub>CCA</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CCA</sub> or GND; I <sub>O</sub> = 0	0.9 - 3.6	0.9 - 3.6	-	5.0	-	10	μA	
			0	0.9 - 3.6	-	-1.0	-	-5.0		
			0.9 - 3.6	0	-	5.0	-	10		
I <sub>CCB</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CCB</sub> or GND; I <sub>O</sub> = 0	0.9 - 3.6	0.9 - 3.6	-	5.0	-	10	μA	
			0	0.9 - 3.6	-	5.0	-	10		
			0.9 - 3.6	0	-	-1.0	-	-5.0		

NOTE: Connect ground before applying supply voltage V<sub>CCA</sub> or V<sub>CCB</sub>. This device is designed with the feature that the power-up sequence of V<sub>CCA</sub> and V<sub>CCB</sub> will not damage the IC.

# NL3V4T244, NL3V4T240, NL3V4T3144

## AC ELECTRICAL CHARACTERISTICS (Notes 5 and 6)

Symbol	Parameter	V <sub>CCA</sub> (V)	T <sub>A</sub> = -40°C to +85°C					T <sub>A</sub> = -40°C to +125°C					Unit
			V <sub>CCB</sub> (V)					V <sub>CCB</sub> (V)					
			3.3	2.5	1.8	1.5	1.2	3.3	2.5	1.8	1.5	1.2	
			Max	Max	Max	Max	Max	Max	Max	Max	Max	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay, A to B	3.3	2.9	3.3	4.5	5.6	9.3	3.3	3.8	5.0	6.2	9.5	nS
		2.5	3.6	3.7	4.6	5.7	9.4	4.0	4.0	5.1	6.3	9.6	
		1.8	3.9	4.0	4.9	6.0	9.6	4.3	4.3	5.4	6.6	9.8	
		1.5	4.2	4.3	5.2	6.3	9.8	4.7	4.7	5.8	7.0	10.0	
		1.2	5.1	5.2	6.2	7.1	11.0	5.7	5.8	6.9	7.9	11.2	
	Propagation Delay, B to A	3.3	2.8	3.0	3.4	4.2	5.1	3.3	3.4	3.9	4.7	5.7	
		2.5	3.3	3.4	3.9	4.2	5.2	3.8	3.9	4.3	4.7	5.8	
		1.8	4.5	4.6	4.9	5.3	6.2	5.0	5.1	5.4	5.9	6.9	
		1.5	5.6	5.7	6.0	6.3	7.1	6.2	6.3	6.6	7.9	7.9	
		1.2	9.3	9.4	9.6	9.8	11.0	9.5	9.6	9.8	10.0	11.2	
t <sub>PZH</sub> , t <sub>PZL</sub>	Output Enable, OE to A	3.3	3.8	3.8	3.8	4.3	5.7	4.2	4.2	4.2	4.5	5.8	nS
		2.5	4.8	4.8	4.8	4.9	6.2	5.3	5.3	5.3	5.3	6.3	
		1.8	7.2	7.2	7.2	7.2	7.5	8.0	8.0	8.0	8.0	8.0	
		1.5	9.4	9.4	9.4	9.4	9.4	10.4	10.4	10.4	10.4	10.4	
		1.2	12.8	12.8	12.8	12.8	13.4	14.1	14.1	14.1	14.1	14.1	
	Output Enable, OE to B	3.3	3.8	4.7	6.8	8.7	11.6	4.2	5.2	7.5	9.6	12.4	
		2.5	4.0	4.8	7.0	8.8	11.6	4.4	5.3	7.7	9.7	12.4	
		1.8	4.6	5.3	7.4	9.2	11.9	5.1	5.9	8.2	10.2	12.9	
		1.5	5.6	5.8	7.7	9.6	12.5	6.2	6.4	8.5	10.6	13.3	
		1.2	7.7	7.9	8.9	10.0	13.9	8.5	8.7	9.8	11.0	14.7	
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Output Disable, OE to A	3.3	5.6	5.6	5.6	5.6	5.6	6.2	6.2	6.2	6.2	6.2	nS
		2.5	6.2	6.2	6.2	6.2	6.2	6.9	6.9	6.9	6.9	6.9	
		1.8	8.6	8.6	8.6	8.6	8.6	9.5	9.5	9.5	9.5	9.5	
		1.5	10.2	10.2	10.2	10.2	10.2	11.3	11.3	11.3	11.3	11.3	
		1.2	10.9	10.9	10.9	10.9	10.9	12.0	12.0	12.0	12.0	12.0	
	Output Disable, OE to B	3.3	6.2	6.4	8.1	9.3	10.2	6.9	7.1	9.0	10.3	11.3	
		2.5	5.2	6.2	8.2	8.8	10.4	5.8	6.9	9.1	10.4	11.5	
		1.8	6.9	6.9	8.7	9.9	10.9	7.6	7.6	9.6	10.9	12.0	
		1.5	7.6	7.4	9.1	10.3	11.3	8.2	8.4	10.1	11.4	12.5	
		1.2	8.1	8.1	9.5	9.6	12.4	9.0	10.1	10.5	10.6	13.7	

5. Propagation delays defined per Figure 3.

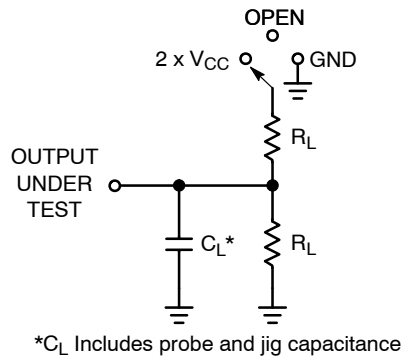
6. These parameters are guaranteed by characterization and are not production tested.

## CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 4)	Unit
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub>	2.5	pF
C <sub>I/O</sub>	I/O Pin Input Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub>	5.0	pF
C <sub>PD</sub> (Note 7)	Power Dissipation Capacitance	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V, V <sub>I</sub> = 0 V or V <sub>CCA</sub> , f = 10 MHz	12	pF

7. C<sub>PD</sub> is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:  
 $I_{CC(operating)} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$  where  $I_{CC} = I_{CCA} + I_{CCB}$  and  $N_{SW}$  = total number of outputs switching.

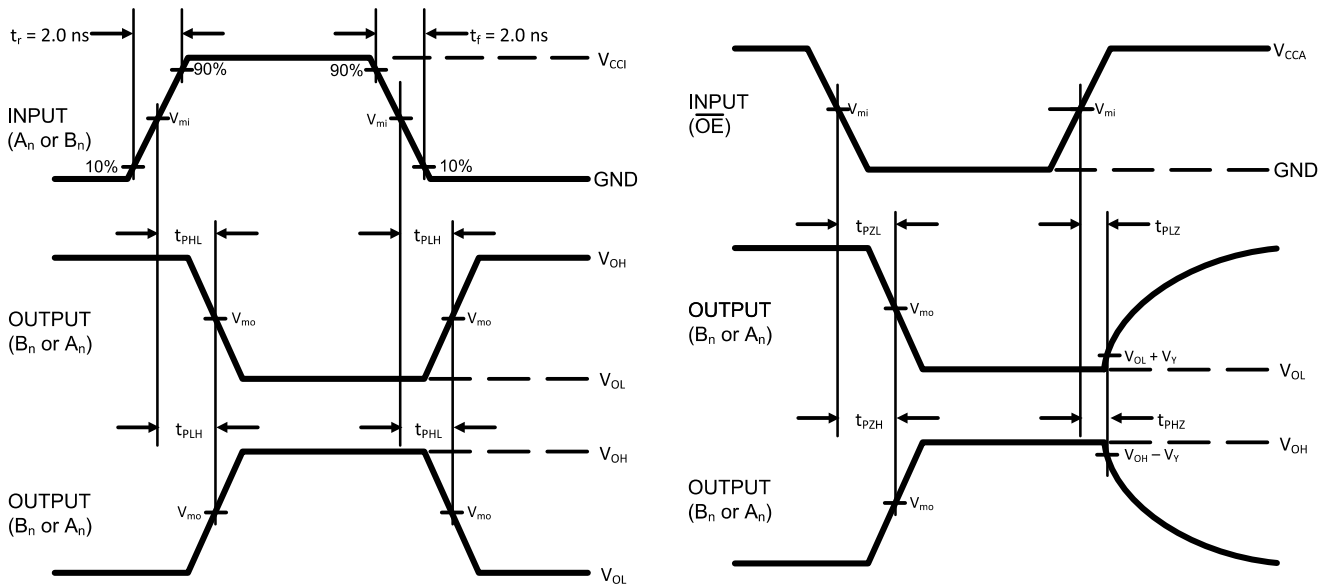
# NL3V4T244, NL3V4T240, NL3V4T3144



**Figure 3. AC Test Circuit**

Test	Switch	C <sub>L</sub>	R <sub>L</sub>
t <sub>PLH</sub> , t <sub>PHL</sub>	OPEN	15 pF	2 kΩ
t <sub>PLZ</sub> , t <sub>PZL</sub>	2 x V <sub>CC</sub>		
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND		

C<sub>L</sub> includes probe and jig capacitance  
Pulse generator Z<sub>O</sub> = 50 Ω  
Input f = 1.0 MHz; t<sub>W</sub> = 500 ns



**Figure 4. AC Waveforms**

Symbol	V <sub>CC</sub>				
	3.0 V – 3.6 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	1.1 V – 1.3 V
V <sub>mi</sub>	V <sub>CCi</sub> /2	V <sub>CCi</sub> /2	V <sub>CCi</sub> /2	V <sub>CCi</sub> /2	V <sub>CCi</sub> /2
V <sub>mo</sub>	V <sub>CCo</sub> /2	V <sub>CCo</sub> /2	V <sub>CCo</sub> /2	V <sub>CCo</sub> /2	V <sub>CCo</sub> /2
V <sub>γ</sub>	0.3 V	0.15 V	0.15 V	0.1 V	0.1 V

- 8. V<sub>CCi</sub> is the V<sub>CC</sub> associated with the input port.
- 9. V<sub>CCo</sub> is the V<sub>CC</sub> associated with the output port.



# NL3V4T244, NL3V4T240, NL3V4T3144

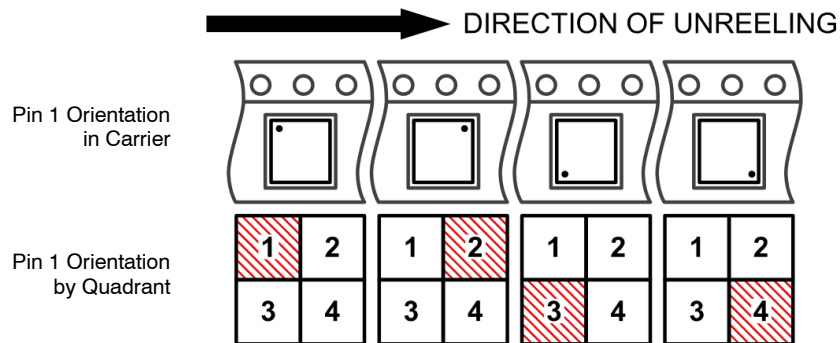
## ORDERING INFORMATION

Device	Marking	Package	Pin 1 Quadrant	Shipping <sup>†</sup>
NL3V4T244MU2TAG	AG	UQFN12	1	3000 Units / Tape & Reel
NL3V4T244MU2TAG-Q*	AG	UQFN12	1	3000 Units / Tape & Reel
NL3V4T244DR2G (Contact <b>onsemi</b> sales)	TBD	SOIC-14	TBD	2500 Units / Tape & Reel
NL3V4T244DTR2G (Contact <b>onsemi</b> sales)	TBD	TSSOP-14	TBD	2500 Units / Tape & Reel
NL3V4T240MU2TAG	AJ	UQFN12	1	3000 Units / Tape & Reel
NL3V4T240DR2G (Contact <b>onsemi</b> sales)	TBD	SOIC-14	TBD	2500 Units / Tape & Reel
NL3V4T240DTR2G (Contact <b>onsemi</b> sales)	TBD	TSSOP-14	TBD	2500 Units / Tape & Reel
NL3V4T3144MU2TAG	AE	UQFN12	1	3000 Units / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

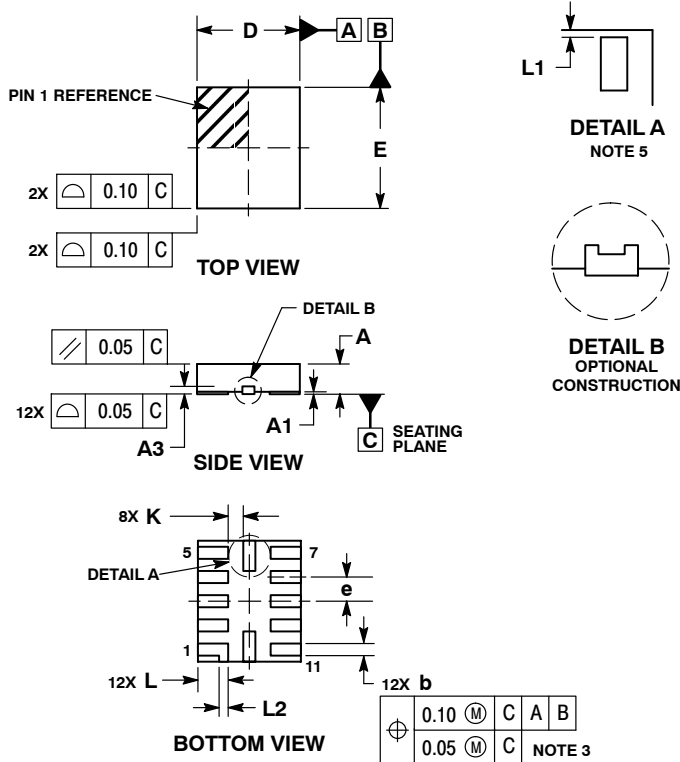
### Pin 1 Orientation in Tape and Reel



# NL3V4T244, NL3V4T240, NL3V4T3144

## PACKAGE DIMENSIONS

UQFN12 1.7x2.0, 0.4P  
CASE 523AE  
ISSUE A

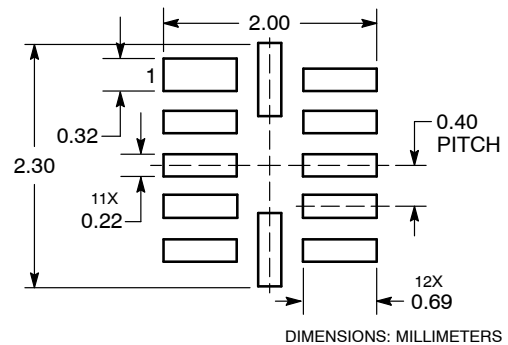


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH 0.03 MAX ON BOTTOM SURFACE OF TERMINALS.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
D	1.70 BSC	
E	2.00 BSC	
e	0.40 BSC	
K	0.20	----
L	0.45	0.55
L1	0.00	0.03
L2	0.15 REF	

### MOUNTING FOOTPRINT SOLDERMASK DEFINED

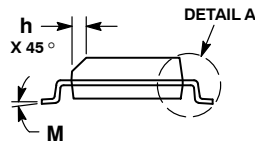
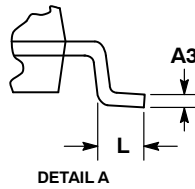
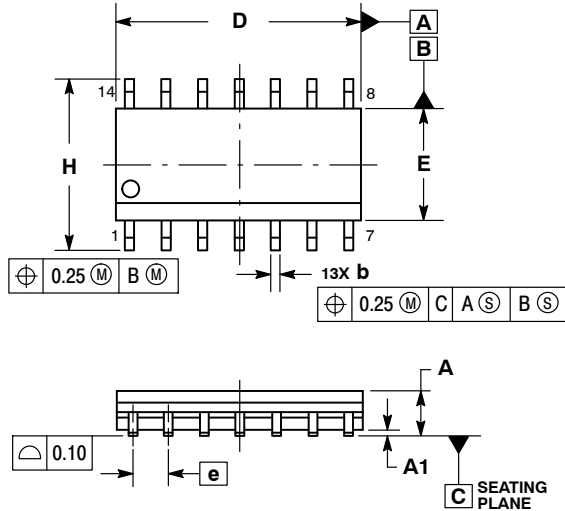


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NL3V4T244, NL3V4T240, NL3V4T3144

## PACKAGE DIMENSIONS

SOIC-14  
D SUFFIX  
CASE 751A-03  
ISSUE L

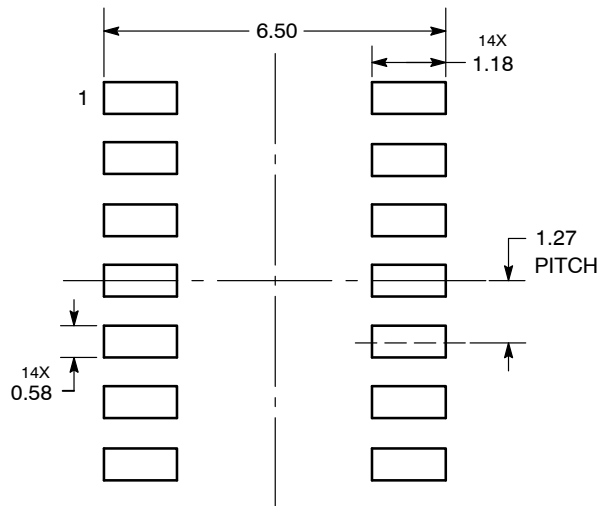


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0°	7°	0°	7°

### SOLDERING FOOTPRINT\*



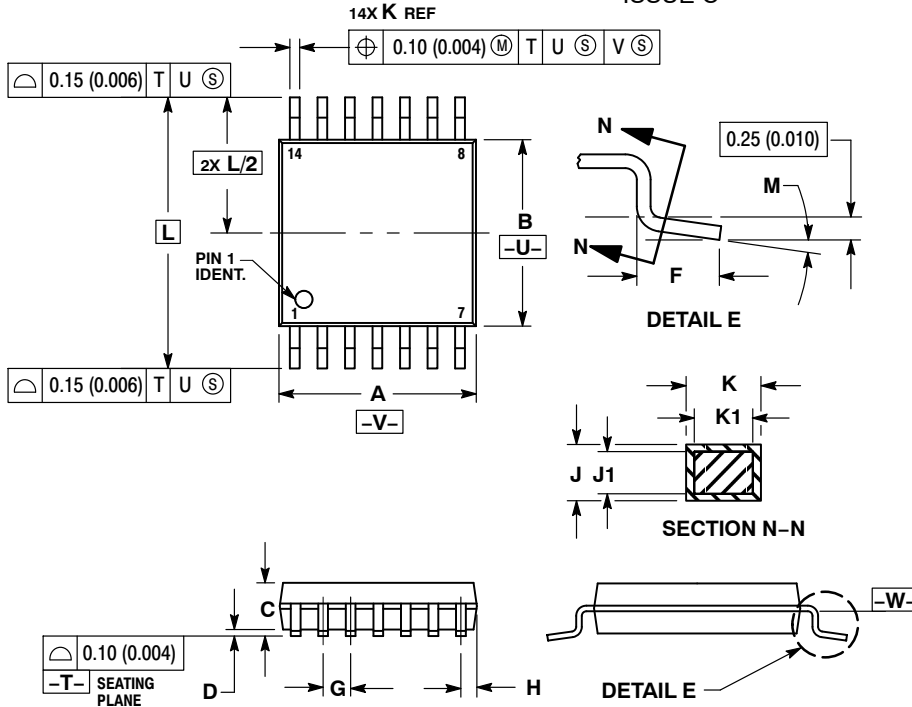
DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# NL3V4T244, NL3V4T240, NL3V4T3144

## PACKAGE DIMENSIONS

TSSOP-14  
DT SUFFIX  
CASE 948G  
ISSUE C

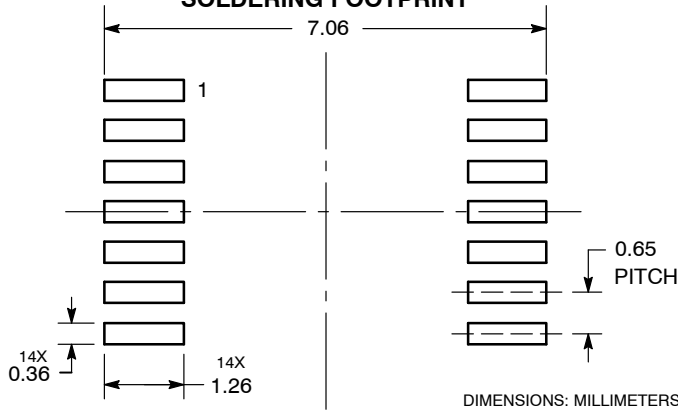


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

### SOLDERING FOOTPRINT



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